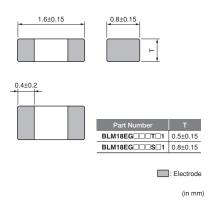
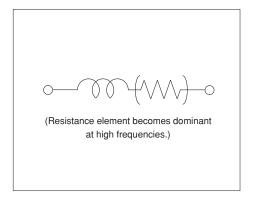
EMIFIL® (Inductor type) Chip Ferrite Bead for GHz Noise

BLM18E Series (0603 Size)

Dimensions



■ Equivalent Circuit



Packaging

Code	Packaging	Minimum Quantity	
D	180mm Paper Tape	4000	
J	330mm Paper Tape	10000	
В	Bulk(Bag)	1000	

■ Rated Value (□: packaging code)

Part Number	Impedance (at 100MHz/20°C)	Impedance (at 1GHz/20°C)	Rated Current	DC Resistance	Operating Temperature Range
BLM18EG101TN1□	100ohm ±25%	140ohm (Typ.)	2000mA	0.045ohm max.	-55 to +125°C
BLM18EG121SN1□	120ohm ±25%	145ohm (Typ.)	2000mA	0.04ohm max.	-55 to +125°C
BLM18EG221SN1□	220ohm ±25%	260ohm (Typ.)	2000mA	0.05ohm max.	-55 to +125°C
BLM18EG221TN1□	220ohm ±25%	300ohm (Typ.)	1000mA	0.15ohm max.	-55 to +125°C
BLM18EG331TN1□	330ohm ±25%	450ohm (Typ.)	500mA	0.21ohm max.	-55 to +125°C
BLM18EG391TN1□	390ohm ±25%	520ohm (Typ.)	500mA	0.3ohm max.	-55 to +125°C
BLM18EG471SN1□	470ohm ±25%	550ohm (Typ.)	500mA	0.21ohm max.	-55 to +125°C
BLM18EG601SN1□	600ohm ±25%	700ohm (Typ.)	500mA	0.35ohm max.	-55 to +125°C

Number of Circuits: 1

Continued on the following page.



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- 2. This datasheet has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specifications or transact the approval sheet for product specifications before ordering.



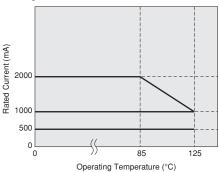
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■ Derating of Rated Current

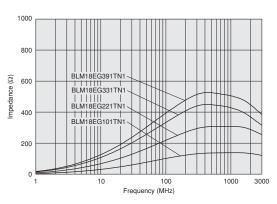
In operating temperature exceeding +85°C, derating of current is necessary for BLM18EG series.

Please apply the derating curve shown in chart according to the operating temperature.

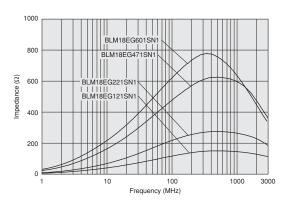
Derating of Rated Current



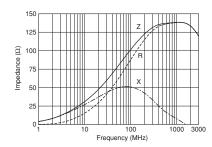
■ Impedance-Frequency Characteristics (Main Items) BLM18EG_TN1 Series



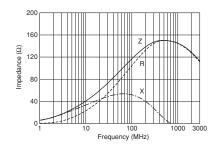
■ Impedance-Frequency Characteristics (Main Items) BLM18EG_SN1 Series



■ Impedance-Frequency Characteristics BLM18EG101TN1



■ Impedance-Frequency Characteristics BLM18EG121SN1



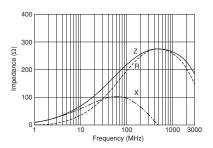
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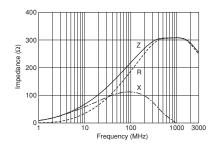
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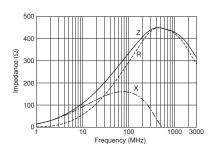
■ Impedance-Frequency Characteristics BLM18EG221SN1



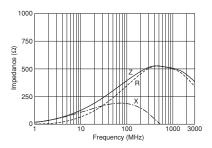
■ Impedance-Frequency Characteristics BLM18EG221TN1



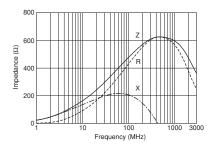
■ Impedance-Frequency Characteristics BLM18EG331TN1



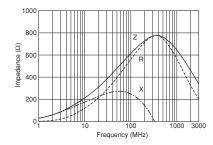
■ Impedance-Frequency Characteristics BLM18EG391TN1



■ Impedance-Frequency Characteristics **BLM18EG471SN1**



■ Impedance-Frequency Characteristics BLM18EG601SN1



Continued on the following page.



3

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Continued from the preceding page.

■ ①Caution/Notice

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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